



# P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY									
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)						
	$0.066$ at $V_{GS} = -4.5 \text{ V}$	- 9 <sup>a</sup>							
- 20	0.094 at V <sub>GS</sub> = - 2.5 V	- 9 <sup>a</sup>	6 nC						
	0.130 at V <sub>GS</sub> = - 1.8 V	- 9 <sup>a</sup>							

#### **FEATURES**

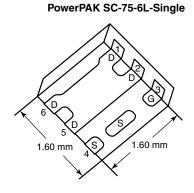
- · Halogen-free
- TrenchFET<sup>®</sup> Power MOSFET
- New Thermally Enhanced PowerPAK<sup>®</sup> SC-75 Package
  - Small Footprint Area
  - Low On-Resistance

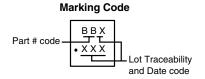


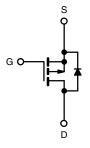
RoHS

#### APPLICATIONS

 Load Switch, PA Switch and Battery Switch for Portable Devices







Ordering Information: SiB411DK-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b>	<b>S</b> T <sub>A</sub> = 25 °C, unle	ss otherwise n	noted		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		$V_{DS}$	- 20	V	
Gate-Source Voltage		$V_{GS}$	± 8		
	T <sub>C</sub> = 25 °C		- 9 <sup>a</sup>		
Continuous Drain Current (T <sub>.I</sub> = 150 °C)	T <sub>C</sub> = 70 °C	1_	- 8.9 <sup>a</sup>		
Continuous Diain Current (1) = 130 C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 4.8 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		- 3.8 <sup>b, c</sup>	Α	
Pulsed Drain Current		I <sub>DM</sub>	- 15		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I_	- 9 <sup>a</sup>		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	Is	- 2 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		13	W	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	$P_D$	8.4		
Maximum Fower Dissipation	T <sub>A</sub> = 25 °C	' D	2.4 <sup>b, c</sup>	1 **	
	T <sub>A</sub> = 70 °C		1.6 <sup>b, c</sup>	1	
Operating Junction and Storage Temperature Ra	ange	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature	e) <sup>d, e</sup>	-	260		

THERMAL RESISTANCE RATINGS									
Parameter		Symbol	Typical	Maximum	Unit				
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 5 s	$R_{thJA}$	41	51	°C/W				
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	7.5	9.5	- O/ VV				

#### Notes:

- a. Package limited.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 s
- d. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SC-75 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 105 °C/W.



<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, unless otherwise noted									
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit			
Static									
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 20			V			
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 18		mV/°C			
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μA		2.2					
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	- 0.4		- 1	V			
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA			
Zoro Coto Voltago Drain Current	l	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V			- 1				
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = - 20 V, $V_{GS}$ = 0 V, $T_J$ = 55 °C			- 10	μΑ			
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le 5 \text{ V}, V_{GS} = -4.5 \text{ V}$	15			Α			
		$V_{GS} = -4.5 \text{ V}, I_D = -3.3 \text{ A}$		0.055	0.066	1			
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -2.5 \text{ V}, I_D = -2.8 \text{ A}$		0.077	0.094	Ω			
		V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 0.77 A		0.107	0.130	7			
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = -10 \text{ V}, I_{D} = -3.3 \text{ A}$		9.5		S			
Dynamic <sup>b</sup>				•		•			
Input Capacitance	C <sub>iss</sub>			470					
Output Capacitance	C <sub>oss</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		95		pF			
Reverse Transfer Capacitance	C <sub>rss</sub>			65					
T. 10 . 0	Q <sub>g</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 8 V, I <sub>D</sub> = - 4.5 A		10	15	1			
Total Gate Charge				6	9				
Gate-Source Charge		$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -4.5 \text{ A}$		0.9		nC			
Gate-Drain Charge	$Q_{gd}$			1.4					
Gate Resistance	$R_g$	f = 1 MHz		7.5		Ω			
Turn-On Delay Time	t <sub>d(on)</sub>			10	15				
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 2.1 $\Omega$		40	60	-			
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ - 4.8 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		45	70				
Fall Time	t <sub>f</sub>			75	115				
Turn-On Delay Time	t <sub>d(on)</sub>			5	10	ns			
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 2.1 $\Omega$		10	15	- - -			
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ - 4.8 A, $V_{GEN}$ = - 8 V, $R_g$ = 1 $\Omega$		25	40				
Fall Time	t <sub>f</sub>			10	15				
Drain-Source Body Diode Characteristi	cs			•		•			
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 9	^			
Pulse Diode Forward Current	I <sub>SM</sub>				15	A			
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = - 3.8 A, V <sub>GS</sub> = 0 V		- 0.85	- 1.2	V			
Body Diode Reverse Recovery Time	t <sub>rr</sub>			20	40	ns			
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	L 2 8 A di/dt _ 100 A/vo T _ 05 °C		10	20	nC			
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = -3.8 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$		15		ns			
Reverse Recovery Rise Time	t <sub>b</sub>			5					

#### Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$ 

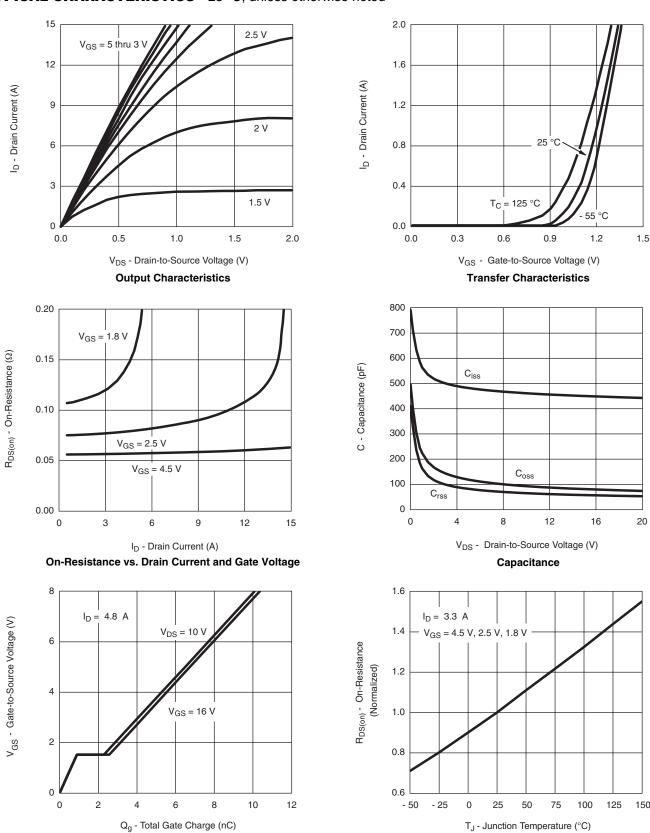
b. Guaranteed by design, not subject to production testing.







### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

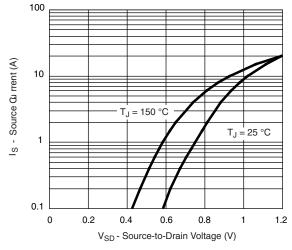


**Gate Charge** 

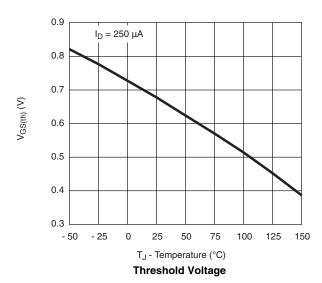
On-Resistance vs. Junction Temperature

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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

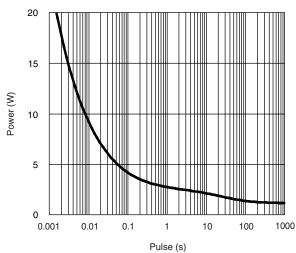


Soure-Drain Diode Forward Voltage

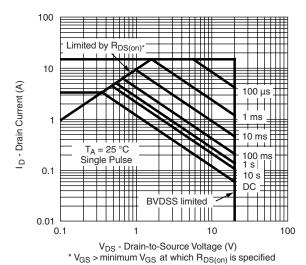


0.20 0.17 0.17 0.14 0.14 0.10 

On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

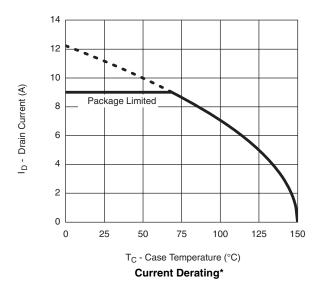


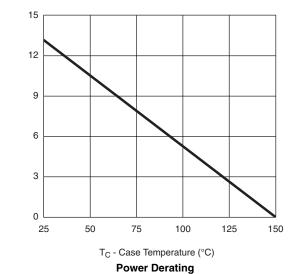
Safe Operating Area, Junction-to-Case





## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Power (W)

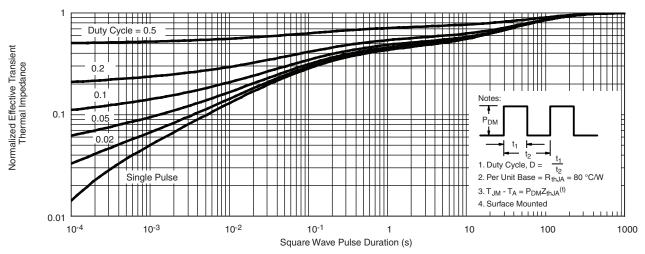
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limit.

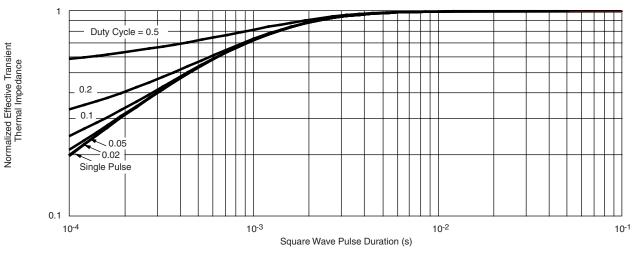
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package

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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



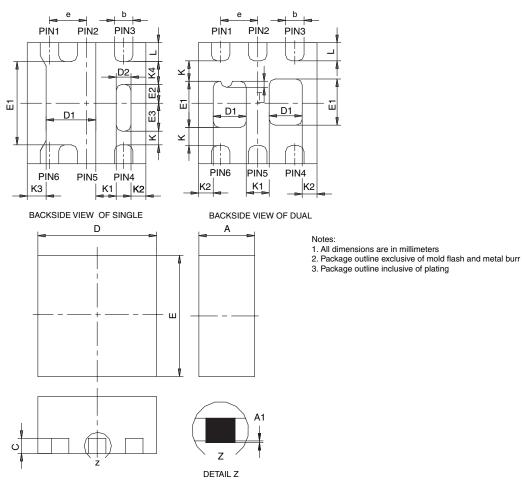
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?74335">http://www.vishay.com/ppg?74335</a>.





PowerPAK® SC75-6L



		SINGLE PAD					DUAL PAD					
DIM	MILLIMETERS			INCHES			MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.18	0.25	0.33	0.007	0.010	0.013	0.18	0.25	0.33	0.007	0.010	0.013
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.53	1.60	1.70	0.060	0.063	0.067	1.53	1.60	1.70	0.060	0.063	0.067
D1	0.57	0.67	0.77	0.022	0.026	0.030	0.34	0.44	0.54	0.013	0.017	0.021
D2	0.10	0.20	0.30	0.004	0.008	0.012						
Е	1.53	1.60	1.70	0.060	0.063	0.067	1.53	1.60	1.70	0.060	0.063	0.067
E1	1.00	1.10	1.20	0.039	0.043	0.047	0.51	0.61	0.71	0.020	0.024	0.028
E2	0.20	0.25	0.30	0.008	0.010	0.012						
E3	0.32	0.37	0.42	0.013	0.015	0.017						
е		0.50 BSC 0.020 BSC		;	0.50 BSC			0.020 BSC				
K	0.180 TYP			0.007 TYP		0.245 TYP (		0.010 TYP				
K1	0.275 TYP				0.011 TYP		0.320 TYP 0.013 TYP					
K2	0.200 TYP				0.008 TYP		0.200 BSC			0.008 TYP		
К3	0.255 TYP				0.010 TYP							
K4	0.300 TYP			0.012 TYP								
L	0.15	0.25	0.35	0.006	0.010	0.014	0.15	0.25	0.35	0.006	0.010	0.014
T							0.03	0.08	0.13	0.001	0.003	0.005

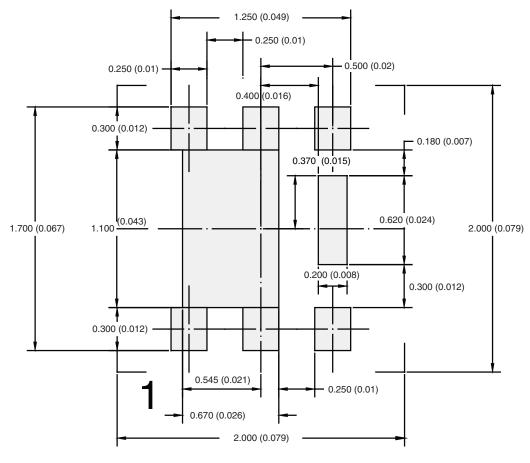
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DWG: 5935

Document Number: 73000 06-Aug-07



## RECOMMENDED PAD LAYOUT FOR PowerPAK® SC75-6L Single



Dimensions in mm/(Inches)

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ATTLICATION NOT



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